

Title (en)

PROCESS FOR PRODUCING A METAL-CERAMIC SUBSTRATE AND SUCH A METAL-CERAMIC SUBSTRATE

Title (de)

VERFAHREN ZUR HERSTELLUNG EINES METALL-KERAMIK-SUBSTRATS UND EIN SOLCHES METALL-KERAMIK-SUBSTRAT

Title (fr)

PROCÉDÉ POUR LA FABRICATION D'UN SUBSTRAT MÉTAL-CÉRAMIQUE ET UN TEL SUBSTRAT MÉTAL-CÉRAMIQUE

Publication

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Application

EP 20713862 A 20200319

Priority

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- EP 2020057628 W 20200319

Abstract (en)

[origin: WO2020200815A1] Process for producing a metal-ceramic substrate (1) comprising: - providing at least one metal layer (12) made of a first metal material and at least one ceramic layer (10) made of a first ceramic material; - providing (101) at least one powder mixture comprising - the first metal material and/or a second metal material and - the first ceramic material and/or a second ceramic material, wherein the at least one powder mixture is preferably in the form of a composite powder; - arranging the at least one powder mixture between the at least one metal layer (12) and the at least one ceramic layer (10) to form a buffer layer (11) between the at least one metal layer (12) and the at least one ceramic layer (10) in the fabricated metal-ceramic substrate (1) and - performing a direct metal bonding process, in particular a direct copper bonding process (105) to form the metal-ceramic substrate, wherein the metal layer and the ceramic layer are joined by the buffer layer (1).

IPC 8 full level

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CPC (source: EP)

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Citation (search report)

See references of WO 2020200815A1

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